<table>
<thead>
<tr>
<th>ALL ARTWORK VIEWED FROM TOP SIDE</th>
<th>BOARD #: TIDA-00130</th>
<th>REV: EZ</th>
<th>SVN REV: Not In VersionControl</th>
</tr>
</thead>
<tbody>
<tr>
<td>LAYER NAME = Top Solder</td>
<td>TIDA-00130 PGA BASED MCB-ETU</td>
<td></td>
<td></td>
</tr>
<tr>
<td>PLDT NAME = Top Solder Mask</td>
<td>GENERATED: 2-21-2014 11:01:59 AM</td>
<td>TEXAS INSTRUMENTS</td>
<td></td>
</tr>
</tbody>
</table>
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